

LNPTM THERMOCOMPTM COMPOUND RF008XXH

RF-1008 HC

DESCRIPTION

 $LNP\ THERMOCOMP\ RF008XXH\ compound\ is\ based\ on\ Nylon\ 6/6\ resin\ containing\ 40\%\ glass\ fiber.\ Added\ features\ of\ this\ grade\ include:\ Healthcare.$

GENERAL INFORMATION	
Features	Healthcare/Formula lock, High stiffness/Strength, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polyamide 66 (Nylon 66)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Hygiene and Healthcare	Pharmaceutical Packaging and Drug Delivery, Surgical devices, General Healthcare, Patient Testing
Packaging	Industrial Packaging

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
(1)			
MECHANICAL (1)			
Tensile Stress, brk, Type I, 5 mm/min	210	MPa	ASTM D638
Tensile Strain, brk, Type I, 5 mm/min	2.9	%	ASTM D638
Tensile Modulus, 5 mm/min	13900	MPa	ASTM D638
Flexural Stress, brk, 1.3 mm/min, 50 mm span	337	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	12400	MPa	ASTM D790
Tensile Stress, break, 5 mm/min	232	MPa	ISO 527
Tensile Strain, break, 5 mm/min	2.9	%	ISO 527
Tensile Modulus, 1 mm/min	14060	MPa	ISO 527
Flexural Stress	229	MPa	ISO 178
Flexural Modulus, 2 mm/min	11170	MPa	ISO 178
IMPACT (1)			
Izod Impact, unnotched, 23°C	1320	J/m	ASTM D4812
Izod Impact, notched, 23°C	166	J/m	ASTM D256
Multiaxial Impact	4	J	ISO 6603
Instrumented Dart Impact Total Energy, 23°C	18	J	ASTM D3763
Izod Impact, unnotched 80*10*4 +23°C	86	kJ/m²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	16	kJ/m²	ISO 180/1A
THERMAL (1)			
HDT, 0.45 MPa, 3.2 mm, unannealed	260	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	253	°C	ASTM D648
CTE, -30°C to 30°C, flow	3.2E-05	1/°C	ASTM D696
CTE, -30°C to 30°C, xflow	6.2E-05	1/°C	ASTM D696
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	259	°C	ISO 75/Bf
		CLIEN	AICTON TILAT NAATTEDCT

© 2024 Copyright by SABIC. All rights reserved

CHEMISTRY THAT MATTERS"



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	244	°C	ISO 75/Af
PHYSICAL (1)			
Specific Gravity	1.5	-	ASTM D792
Density	1.48	g/cm³	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.66	%	ASTM D570
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.2 – 0.4	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	1 – 3	%	ASTM D955
Moisture Absorption (23°C / 50% RH)	1	%	ISO 62
INJECTION MOLDING (3)			
Drying Temperature	80	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.15 – 0.25	%	
Melt Temperature	280 – 305	°C	
Front - Zone 3 Temperature	295 – 305	°C	
Middle - Zone 2 Temperature	280 – 295	°C	
Rear - Zone 1 Temperature	265 – 275	°C	
Mold Temperature	95 – 110	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

DISCLAIMER

Any sale by SABIC, its subsidiaries and affiliates (each a "seller"), is made exclusively under seller's standard conditions of sale (available upon request) unless agreed otherwise in writing and signed on behalf of the seller. While the information contained herein is given in good faith, SELLER MAKES NO WARRANTY, EXPRESS OR IMPLIED, INCLUDING MERCHANTABILITY AND NONINFRINGEMENT OF INTELLECTUAL PROPERTY, NOR ASSUMES ANY LIABILITY, DIRECT OR INDIRECT, WITH RESPECT TO THE PERFORMANCE, SUITABILITY OR FITNESS FOR INTENDED USE OR PURPOSE OF THESE PRODUCTS IN ANY APPLICATION. Each customer must determine the suitability of seller materials for the customer's particular use through appropriate testing and analysis. No statement by seller concerning a possible use of any product, service or design is intended, or should be construed, to grant any license under any patent or other intellectual property right.